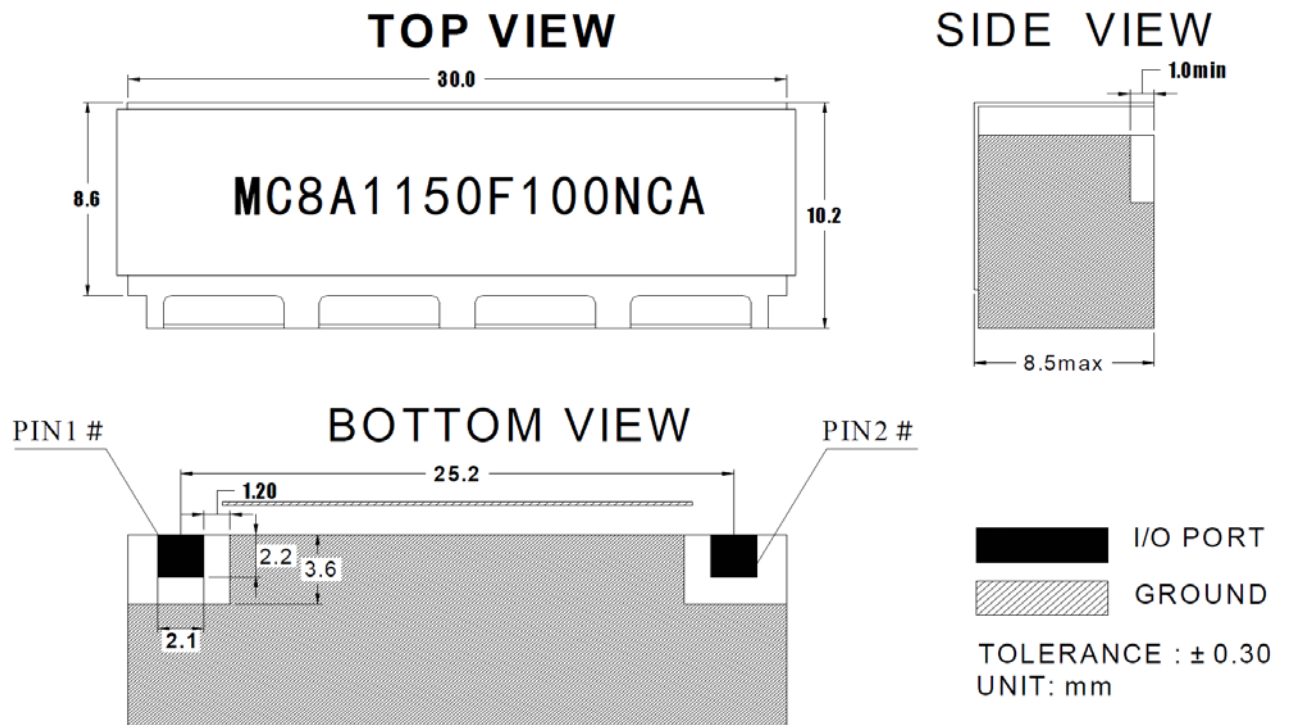


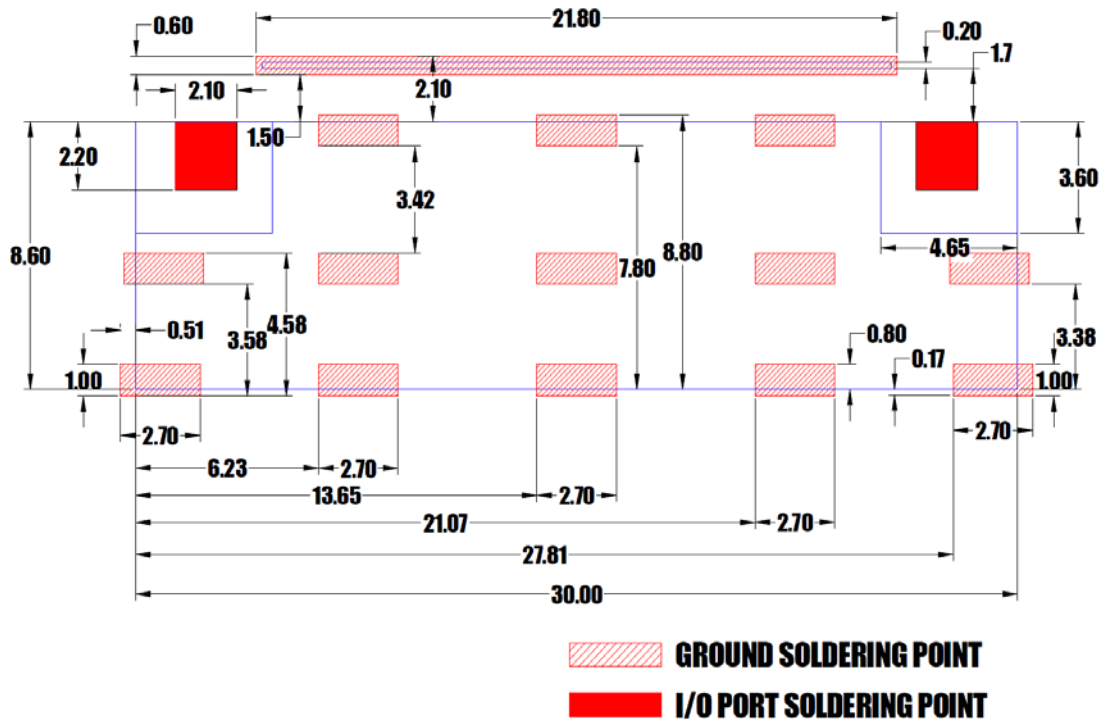
Electrical Specification

Parameter	Specification	Unit
Center Frequency	1150	MHz
Bandwidth (BW)	$F_0 \pm 50 [1100 \sim 1200]$	MHz
Insertion Loss in BW	2.5 max.	dB
Ripple in BW	1.0 max.	dB
Return Loss in BW	15 min.	dB
Attenuation (Absolute Value)	40 min.@DC~900 MHz	dB
	20 min.@1000~1080 MHz	
	20 min.@1220~1300 MHz	
	40 min.@1300~1700 MHz	
Impedance	50	ohm
Input Power	25 max.	dBm
Operating Temperature	-40 to +85	°C
Quantity	5	PCS

Outline Drawing



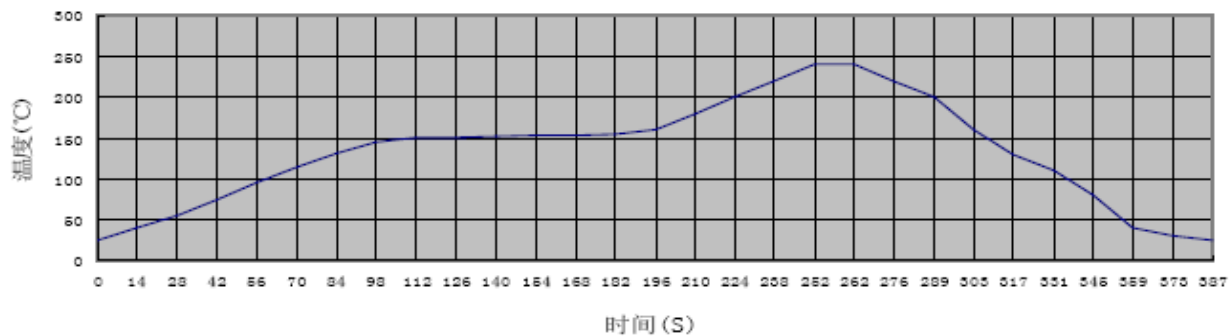
Recommended PCB Layout



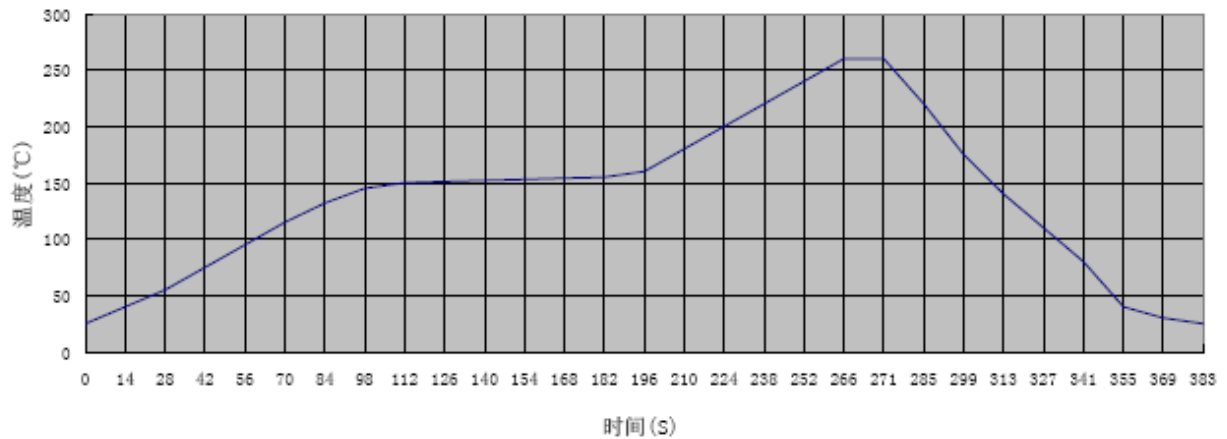
Remarks: Recommend to use silver-containing solder paste

Application Instructions:

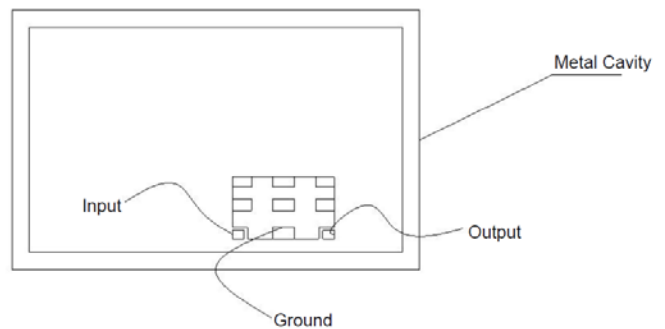
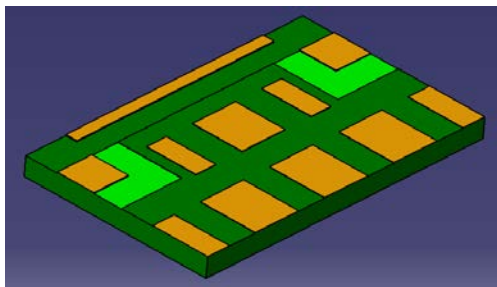
1. Recommended Soldering Temperature
 - a. Containing Pb Soldering,
Recommend the solder paste of melting points 183°C, soldering temperature won't exceed 230°C. Refer to the below reflow soldering profile.



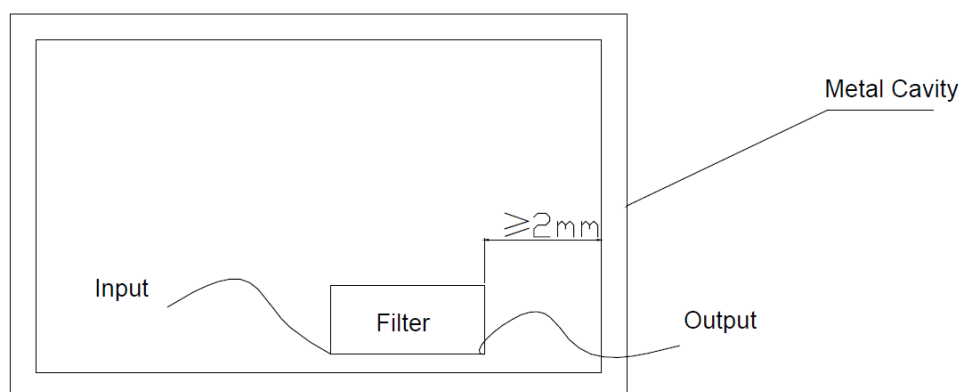
- b. Pb-free soldering
Recommend the solder paste of melting point 217°C, soldering temperature won't exceed 260°C. Refer to the below reflow soldering profile.



- PCB layout for soldering the filter should be designed in grid pattern. Refer to recommended PCB Layout for more details. Soldering Area is 50%-70% of ground area of this filter.



- This filter should be soldered 2mm (at least) away from metal cavity, in order to avoid degrading filter's performance by metal cavity. Refer to the below figure.



- It would achieve better performance that the top of the filter is grounded too.
- Mounting screws around the filter should be 1cm away from the filter.
- To avoid PCB transformation during mounting the filter.
- If customer will solder PCB of the filter on Aluminum plate, please contact us directly.